

FPN630 FPN630A



PNP Low Saturation Transistor

These devices are designed for high current gain and low saturation voltage with collector currents up to 3.0 A continuous. Sourced from Process PC.

Absolute Maximum Ratings* TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V _{CEO}	Collector-Emitter Voltage	30	V	
V _{CBO}	Collector-Base Voltage	35	V	
V _{EBO}	Emitter-Base Voltage	5.0	V	
I _C	Collector Current - Continuous	3.0	A	
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C	

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

3) All voltages (V) and currents (A) are negative polarity for PNP transistors.

Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units	
		FPN630 / FPN630A		
P _D	Total Device Dissipation	1.0	W	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	50	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	125	°C/W	

PNP Low Saturation Transistor

Min

(continued)

Max Units

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Parameter

TA = 25°C unless otherwise noted

Test Conditions

OFF CHA	ARACTERISTICS				
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 10 \text{ mA}, I_B = 0$	30		V
BV _{CBO}	Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	35		V
BV _{EBO}	Emitter-Base Breakdown Voltage	$I_E = 100 \mu A, I_C = 0$	5.0		V
I _{CBO}	Collector Cutoff Current	V _{CB} = 30 V, I _E = 0 V _{CB} = 30 V, I _E = 0, T _A = 100°C		100 10	nA μA
I _{EBO}	Emitter Cutoff Current	$V_{EB} = 4.0 \text{ V}, I_{C} = 0$		100	nA

ON CHARACTERISTICS*

Symbol

h _{FE}	DC Current Gain	$I_C = 100 \text{ mA}, V_{CE} = 2.0 \text{ V}$	630	100		
			630A	250		
		$I_C = 1.0 \text{ A}, V_{CE} = 2.0 \text{ V}$		60		
		$I_C = 2.0 \text{ A}, V_{CE} = 2.0 \text{ V}$		40		
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 1.0 \text{ A}, I_B = 100 \text{ mA}$	630		300	mV
-(,			630A		250	mV
		$I_C = 2.0 \text{ A}, I_B = 200 \text{ mA}$			500	mV
V _{BE(sat)}	Base-Emitter Saturation Voltage	$I_C = 1.0 \text{ A}, I_B = 100 \text{ mA}$			1.25	V
V _{BE(on)}	Base-Emitter Saturation Voltage	$I_C = 1.0 \text{ A}, V_{CE} = 2.0 \text{ V}$			1.0	V

SMALL SIGNAL CHARACTERISTICS

Cobo	Output Capacitance	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1.0 \text{ MHz}$		100	pF
F _T	Transition Frequency	$I_C = 100 \text{ mA}, V_{CE} = 5.0 \text{ V},$ f = 100 MHz	100		MHz

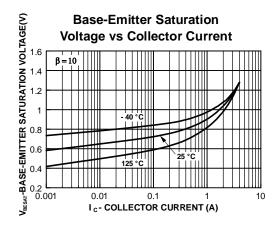
^{*}Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

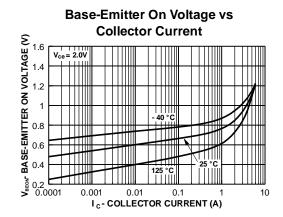
NOTE: All voltages (V) and currents (A) are negative polarity for PNP transistors.

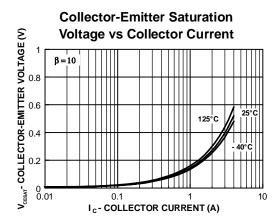
PNP Low Saturation Transistor

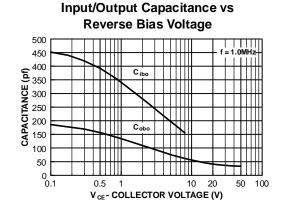
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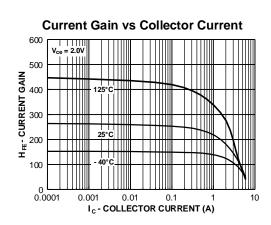
Typical Characteristics

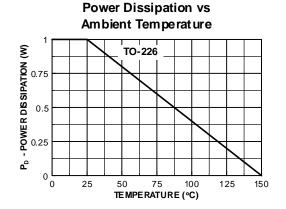












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